



FUKUCOM COMPANY LTD.

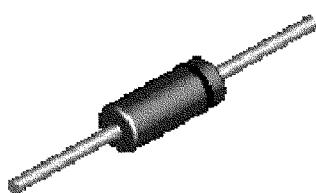
福 靈 有 限 公 司

FLAT P, 3/F, EVEREST INDUSTRIAL CENTRE, 396 KWUN TONG ROAD,
KWUN TONG, KOWLOON, HONG KONG.
TEL: 2790-0314 FAX: 2790-0206

1N/FDLL 914/A/B / 916/A/B / 4148 / 4448

FAIRCHILD
SEMICONDUCTOR®

1N/FDLL 914/A/B / 916/A/B / 4148 / 4448



DO-35



LL-34

THE PLACEMENT OF THE EXPANSION GAP
HAS NO RELATIONSHIP TO THE LOCATION
OF THE CATHODE TERMINAL

COLOR BAND MARKING		
DEVICE	1ST BAND	2ND BAND
FDLL914	BLACK	BROWN
FDLL914A	BLACK	GRAY
FDLL914B	BROWN	BLACK
FDLL916	BLACK	RED
FDLL916A	BLACK	WHITE
FDLL916B	BROWN	BROWN
FDLL4148	BLACK	BROWN
FDLL4448	BROWN	BLACK

Small Signal Diode

Absolute Maximum Ratings*

T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Maximum Repetitive Reverse Voltage	100	V
I _{F(AV)}	Average Rectified Forward Current	200	mA
I _{FSM}	Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 1.0 microsecond	1.0 4.0	A A
T _{stg}	Storage Temperature Range	-65 to +200	°C
T _J	Operating Junction Temperature	175	°C

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- 1) These ratings are based on a maximum junction temperature of 200 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

Symbol	Characteristic	Max	Units
		1N/FDLL 914/A/B / 4148 / 4448	
P _D	Power Dissipation	500	mW
R _{θJA}	Thermal Resistance, Junction to Ambient	300	°C/W



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Small Signal Diode (continued)

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
V_R	Breakdown Voltage	$I_R = 100 \mu\text{A}$ $I_R = 5.0 \mu\text{A}$	100		V
V_F	Forward Voltage 1N914B/4448 1N916B 1N914/916/4148 1N914A/916A 1N916B 1N914B/4448	$I_F = 5.0 \text{ mA}$	620	720	mV
		$I_F = 5.0 \text{ mA}$	630	730	mV
		$I_F = 10 \text{ mA}$		1.0	V
		$I_F = 20 \text{ mA}$		1.0	V
		$I_F = 20 \text{ mA}$		1.0	V
		$I_F = 100 \text{ mA}$		1.0	V
I_R	Reverse Current	$V_R = 20 \text{ V}$ $V_R = 20 \text{ V}, T_A = 150^\circ\text{C}$ $V_R = 75 \text{ V}$		25	nA
				50	μA
				5.0	μA
C_T	Total Capacitance 1N916A/B/4448 1N914A/B/4148	$V_R = 0, f = 1.0 \text{ MHz}$ $V_R = 0, f = 1.0 \text{ MHz}$		2.0	pF
				4.0	pF
t_{rr}	Reverse Recovery Time	$I_F = 10 \text{ mA}, V_R = 6.0 \text{ V} (60\text{mA}),$ $I_{rr} = 1.0 \text{ mA}, R_L = 100\Omega$		4.0	ns

Typical Characteristics

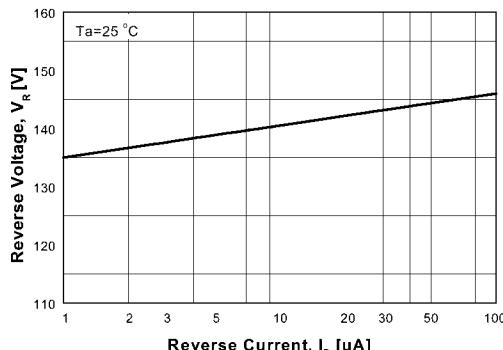
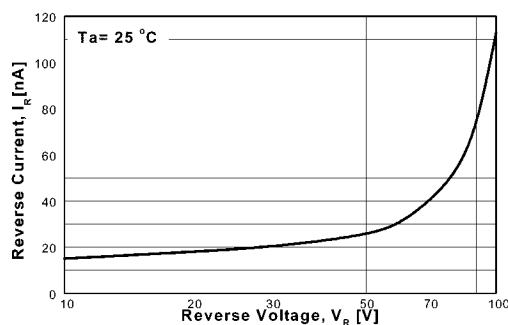


Figure 1. Reverse Voltage vs Reverse Current
BV - 1.0 to 100 μA



GENERAL RULE: The Reverse Current of a diode will approximately double for every ten (10) Degree C increase in Temperature
Figure 2. Reverse Current vs Reverse Voltage
IR - 10 to 100 V

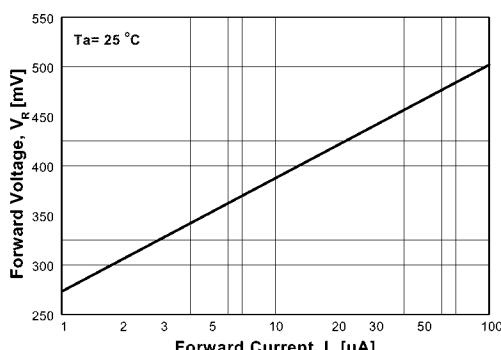


Figure 3. Forward Voltage vs Forward Current
VF - 1 to 100 μA

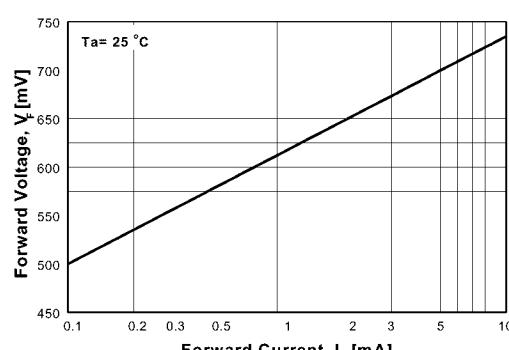


Figure 4. Forward Voltage vs Forward Current
VF - 0.1 to 10 mA



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Small Signal Diode (continued)

Typical Characteristics (continued)

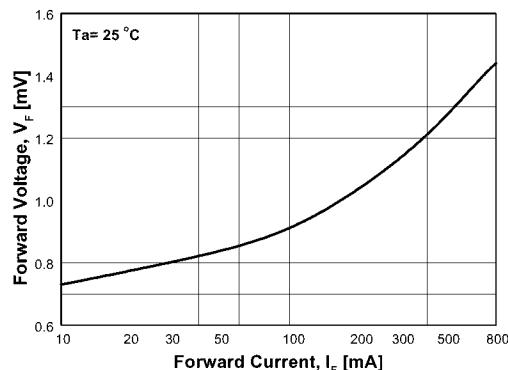


Figure 5. Forward Voltage vs Forward Current
VF - 10 to 800 mA

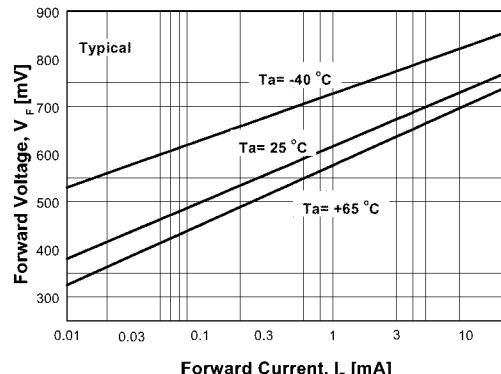


Figure 6. Forward Voltage
vs Ambient Temperature
VF - 0.01 - 20 mA (-40 to +65 Deg C)

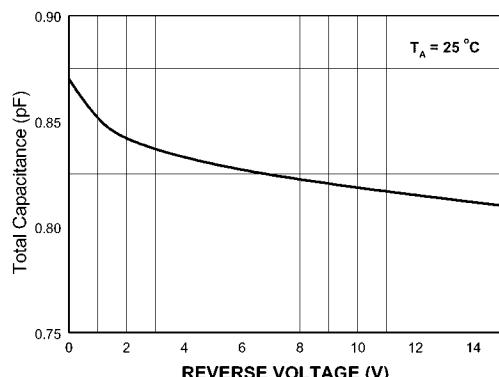


Figure 7. Total Capacitance

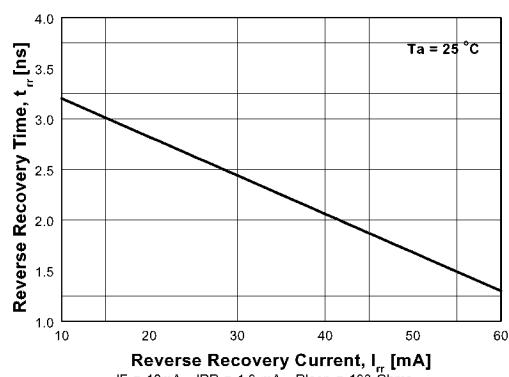


Figure 8. Reverse Recovery Time vs
Reverse Recovery Current

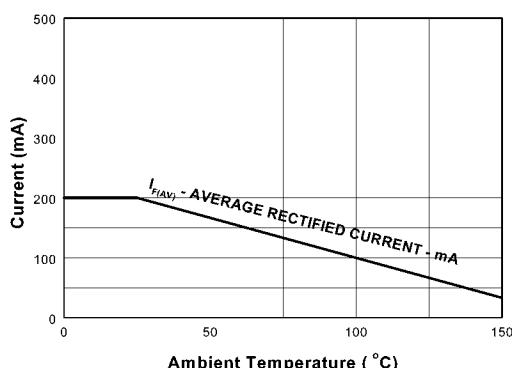


Figure 9. Average Rectified Current ($I_{F(AV)}$)
versus Ambient Temperature (T_A)

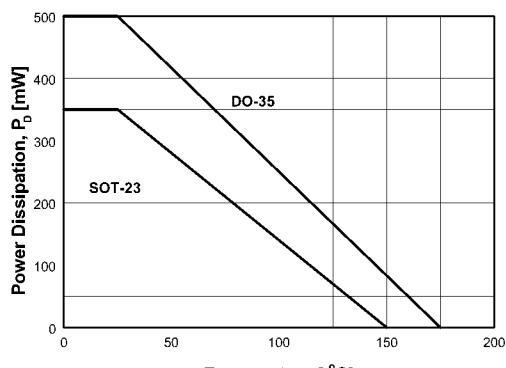


Figure 10. Power Derating Curve



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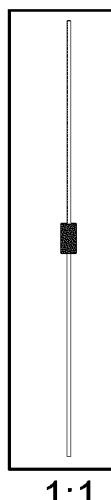
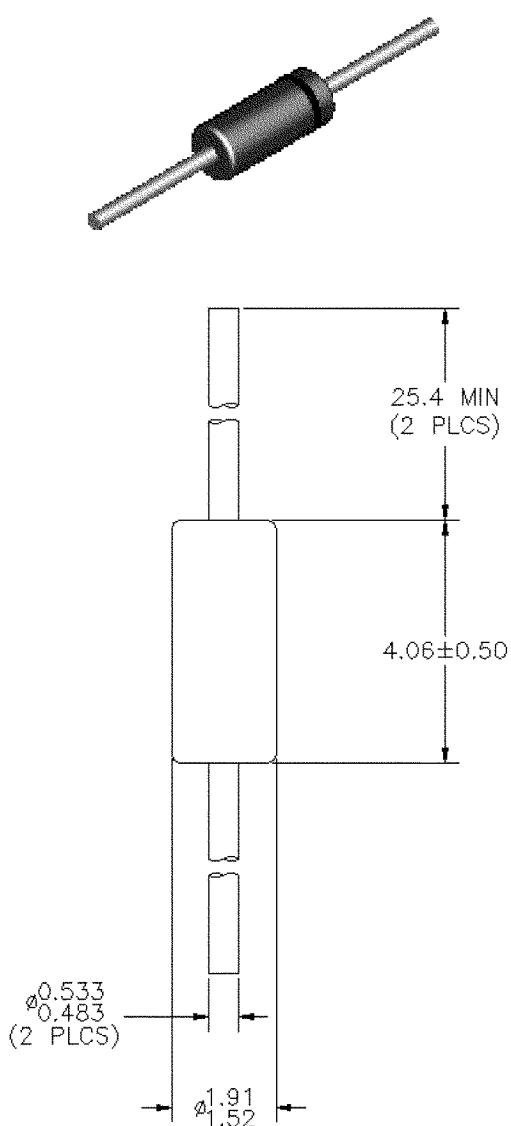
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DO-35 Package Dimensions

FAIRCHILD
SEMICONDUCTOR™

DO-35 (FS PKG Code D2)



Scale 1:1 on letter size paper
Dimensions shown below are in millimeters
Part Weight per unit (gram): 0.137

NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO JEDEC DO-204, VAR. AH, ISSUE B,
DATED JANUARY 20, 1976.
- B) HERMITICALLY SEALED GLASS PACKAGE